SDLS103

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

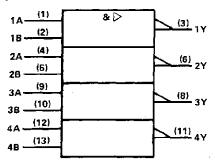
These devices contain four independent 2-input NAND buffer gates.

The SN5437, SN54LS37 and SN54S37 are characterized for operation over the full military range of -55 °C to 125 °C. The SN7437, SN74LS37 and SN74S37 are characterized for operation from 0 °C to 70 °C.

FUNCTION TABLE (each gate)

INP	UTS	Ουτρυτ
A	B	Y
н	н	L
L	x	н
Х	L	Н

logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

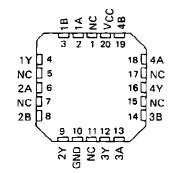
Pin numbers shown are for D, J, N, and W packages.

SN5437, SN54LS37, SN54S37, SN7437, SN74LS37, SN74S37 OUADRUPLE 2-INPUT POSITIVE-NAND BUFFERS December 1983-Revised March 1988

> SN5437, SN54LS37, SN54S37.... J OR W PACKAGE SN7437.... N PACKAGE SN74LS37, SN74S37.... D OR N PACKAGE (TOP VIEW)

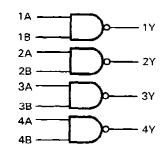
1A [] 1B []2 1Y []3 2A []4 2B []5	U 14 VCC 13 48 12 4A 11 4Y 10 3B
	10 3B
2Y 🗖 6	9 <mark>Д</mark> ЗА
GND [7	8] 3Y

SN54LS37, SN54S37 ... FK PACKAGE (TOP VIEW)



NC ~ No internal connection

logic diagram



positive logic

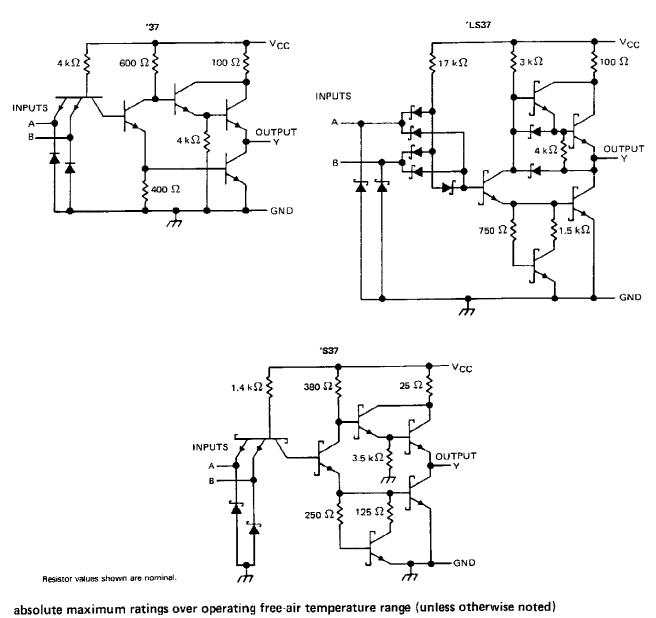
$$Y = \overline{A \cdot B}$$
 or $Y = \overline{A} + \overline{B}$

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard werrenty. Production processing does not necessarily include testing of all parameters.



SN5437, SN54LS37, SN437 SN7437, SN74LS37, SN7437 QUADRUPLE 2-INPUT POSITIVE-NAND BUFFERS

schematics (each gate)



)	
ʻ1 S37		
Operating free-air temperature:	\$N54'	
	SN74' ,	
Storage temperature range		

NOTE 1: Voltage values are with respect to network ground terminal.

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recommended operating conditions

		SN5437			SN7437			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
VCC Supply voltage		4.5	5	5.5	4.75	5	5.25	V
VIH High-level input voltage		2			2			V
VIL Low-level input voltage			-	0.8			0.8	V
IOH High-level output current				- 1.2			- 1.2	mA
IOL Low-level output current				48			48	mΑ
TA Operating free-sir temperatu	re	- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDIT			SN5437		SN7437			UNIT
PARAMETER	TEST CONDITIONS I			MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V _{CC} ≈ MIN,	l _l = – 12 mA				- 1.5	1		- 1.5	V
VOH	V _{CC} = MIN,	V _{IL} =0.8 V,	IOH = - 1.2 mA	2.4	3.3		2.4	3.3		V
VOL	VCC ~ MIN,	V _{IH} = 2 V,	loL = 48 mA		0.2	0.4		0.2	0.4	V
1	V _{CC} = MAX,	V ₁ = 6.5 V				1			1	mA
Тн	VCC = MAX,	V = 2.4 V				40	Γ		40	μA
ЧL	VCC = MAX,	V ₁ = 0.4 V				- 1.6	[- 1.6	mA
los§	V _{CC} = MAX			- 20		- 70	- 18	·	- 70	mA
ГССН	V _{CC} ≈ MAX,	V ₁ = 0 V			9	15.5	_	9	15.5	mA
ICCL	V _{CC} = MAX,	V ₁ = 4.5 V			34	54		34	54	mΑ

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

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\$ All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$. \$ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25 $^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	TEST CONDITIONS			MAX	UNIT
tPLH	A or B	· · ·	R ₁ = 133 Ω,	C ₁ = 45 pF		13	22	กร
TPHL	A 01 B	·	n 133 32,			8	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



SN54LS37, SN74LS37 QUADRUPLE 2-INPUT POSITIVE-NAND BUFFERS

recommended operating conditions

	SN54LS37 SN74LS37	UNIT
	MIN NOM MAX MIN NOM MAX	
V _{CC} Supply voitage	4.5 5 5.5 4.75 5 5.25	V
VIH High-level input voltage	2 2	
VIL Low-level input voltage	0.7 0.8	V
OH High-level output current	-1.2 -1.2	mA
OL Low-level output current	12 24	mA
TA Operating free-air temperature	-55 125 0 70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS T			5	SN54LS37			SN74LS37		
FARAMETER		TES: CONDITIONS (TYP‡	MAX	MIN	TYP‡	MAX	UNIT
٧IK	V _{CC} = MIN,	iι = - 18 mA				- 1.5			- 1.5	V
V _{OH}	V _{CC} = MIN,	V _{IL} ≖ MAX,	юн = – 1.2 mA	2.5	3.4		2.7	3.4		V
Ve	V _{CC} = MIN,	V _{IH} = 2 V,	1 ₀₁ = 12 mA		0.25	0.4		0.25	0.4	v
Vol	V _{CC} = MIN,	V _{JH} = 2 V,	<u>lol = 24 mA</u>					0.35	0.5	1 ĭ
կ	V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mΑ
ЧΗ	V _{CC} = MAX,	V _I ≠ 2.7 V				20			20	μA
μ	V _{CC} = MAX,	V ₁ = 0.4 V		_		- 0.4			- 0.4	mA
IOS §	V _{CC} = MAX			- 30		130	- 30		- 130	mA
Іссн_	VCC = MAX,	V1 = 0 V			0.9	2		0.9	2	mΑ
^I CCL	V _{CC} = MAX,	V _I = 4.5 V		_	6	12		6	12	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

...

[‡] All typical values are at V_{CC} = 5 V, T_A = 25° C. § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN TYP	MAX	UNIT	
^t PLH	A or B	v	P 667 0		12	24	ns
^t PH∟	AOIB		R _L = 667 Ω,	CL = 45 pF	12	24	រាន

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



SN54S37, SN74S37 QUADRUPLE 2-INPUT POSITIVE-NAND BUFFERS

recommended operating conditions

			\$N54\$37			SN74S37			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.75	- 5	5.25	V	
VIН	High-level input voltage	2			2		_	V	
VIL	Low-level input voltage			0.8			0.8	V	
юн	High-level output current			- 3			- 3	mA	
IOL.	Low-level output current			60			60	mA	
TA	Operating free-air temperature	- 55		125	0		70	°c	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONDITIONS [†]	SN54S37	SN74S37	
PARAMETER	TEST CONDITIONS (ΜΙΝ ΤΥΡ‡ ΜΑΧ	MIN TYP: MAX	יואט ך
VIK	$V_{CC} = MIN, I_1 = -18 \text{ mA}$	- 1.2	- 1.2	V
VOH	$V_{CC} = MIN$, $V_{IL} = 0.8 V$, $l_{OH} = -3 mA$	2.5 3.4	2.7 3.4	V
VOL	V _{CC} = MIN, V _{IH} = 2 V, I _{OL} = 60 mA	0.5	0.5	V
1	V _{CC} = MAX, VI = 5.5 V	1	1	mA
Чн	V _{CC} = MAX, V _I = 2.7 V	0.1	0.1	mΑ
11	V _{CC} = MAX, V _I = 0.5 V	-4	- 4	mA
los§	V _{CC} = MAX	- 50 - 225	- 50 - 225	mA
ГССН	$V_{CC} = MAX, V_1 = 0 V$	20 36	20 36	mA
ICCL	V _{CC} = MAX, V _I = 4.5	46 80	46 80	mA

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† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$. § Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed 100 milliseconds.

FROM то PARAMETER TEST CONDITIONS UNIT MIN TYP MAX (INPUT) (OUTPUT) 4 6.5 ^tPLH ns C_L = 50 pF $R_{\rm L}$ = 93 Ω_{\star} 4 ^tPHL 6.5 ns Y A or B 6 ^tPLH ΠS $\mathsf{R}_{\mathsf{L}}=93~\Omega,$ C_L = 150 pF 6 [†]PHL ns

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$ (see note 2)

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.





PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962-9754101Q2A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 9754101Q2A SNJ54LS 37FK
5962-9754101QCA	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9754101QC A SNJ54LS37J
5962-9754101QCA	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9754101QC A SNJ54LS37J
5962-9754101QDA	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9754101QD A SNJ54LS37W
5962-9754101QDA	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9754101QD A SNJ54LS37W
SN54LS37J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS37J
SN54LS37J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS37J
SN54LS37J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS37J
SN54LS37J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS37J
SN54S37J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54S37J
SN54S37J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54S37J
SN54S37J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54S37J
SN54S37J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54S37J
SN74LS37N	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS37N
SN74LS37N	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS37N
SN74LS37N.A	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS37N
SN74LS37N.A	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS37N
SN74LS37NSR	Active	Production	SOP (NS) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS37
SN74LS37NSR	Active	Production	SOP (NS) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS37
SN74LS37NSR.A	Active	Production	SOP (NS) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS37
SN74LS37NSR.A	Active	Production	SOP (NS) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS37



29-May-2025

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	(3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN74S37D	Active	Production	SOIC (D) 14	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	S37
SN74S37D	Active	Production	SOIC (D) 14	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	S37
SN74S37D.A	Active	Production	SOIC (D) 14	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	S37
SN74S37D.A	Active	Production	SOIC (D) 14	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	S37
SN74S37N	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74S37N
SN74S37N	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74S37N
SN74S37N.A	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74S37N
SN74S37N.A	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74S37N
SNJ54LS37FK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 9754101Q2A SNJ54LS 37FK
SNJ54LS37FK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 9754101Q2A SNJ54LS 37FK
SNJ54LS37FK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 9754101Q2A SNJ54LS 37FK
SNJ54LS37FK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 9754101Q2A SNJ54LS 37FK
SNJ54LS37J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9754101Q0 A SNJ54LS37J
SNJ54LS37J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9754101Q0 A SNJ54LS37J
SNJ54LS37J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9754101Q0 A SNJ54LS37J
SNJ54LS37J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9754101Q0 A SNJ54LS37J



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Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	(3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SNJ54LS37W	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9754101QD A SNJ54LS37W
SNJ54LS37W	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9754101QD A SNJ54LS37W
SNJ54LS37W.A	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9754101QD A SNJ54LS37W
SNJ54LS37W.A	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9754101QD A SNJ54LS37W
SNJ54S37FK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S 37FK
SNJ54S37FK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S 37FK
SNJ54S37FK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	N/A for Pkg Type -55 to 125	
SNJ54S37FK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S 37FK
SNJ54S37J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S37J
SNJ54S37J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S37J
SNJ54S37J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S37J
SNJ54S37J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S37J
SNJ54S37W	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S37W
SNJ54S37W	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S37W
SNJ54S37W.A	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S37W
SNJ54S37W.A	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S37W

⁽¹⁾ Status: For more details on status, see our product life cycle.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.



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⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54LS37, SN54S37, SN74LS37, SN74S37 :

• Catalog : SN74LS37, SN74S37

• Military : SN54LS37, SN54S37

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications



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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All	dimensions	are	nominal	

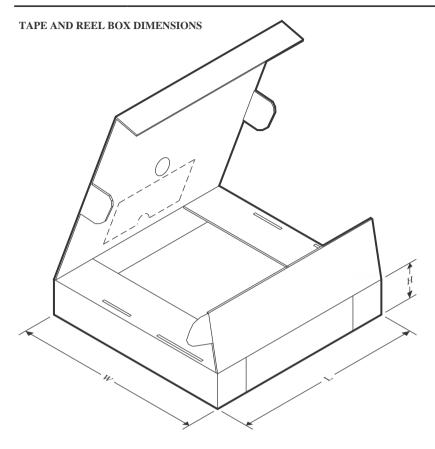
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS37NSR	SOP	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



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PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

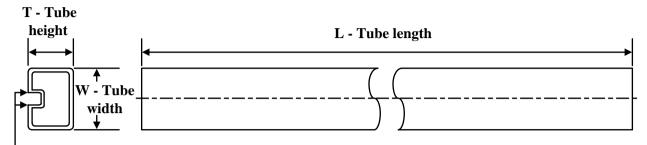
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS37NSR	SOP	NS	14	2000	356.0	356.0	35.0

TEXAS INSTRUMENTS

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TUBE



- B - Alignment groove width

*All dimensions are nor	ninal
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Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962-9754101Q2A	FK	LCCC	20	55	506.98	12.06	2030	NA
5962-9754101QDA	W	CFP	14	25	506.98	26.16	6220	NA
SN74LS37N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS37N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS37N.A	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS37N.A	N	PDIP	14	25	506	13.97	11230	4.32
SN74S37D	D	SOIC	14	50	506.6	8	3940	4.32
SN74S37D.A	D	SOIC	14	50	506.6	8	3940	4.32
SN74S37N	N	PDIP	14	25	506	13.97	11230	4.32
SN74S37N	N	PDIP	14	25	506	13.97	11230	4.32
SN74S37N.A	N	PDIP	14	25	506	13.97	11230	4.32
SN74S37N.A	N	PDIP	14	25	506	13.97	11230	4.32
SNJ54LS37FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS37FK.A	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS37W	W	CFP	14	25	506.98	26.16	6220	NA
SNJ54LS37W.A	W	CFP	14	25	506.98	26.16	6220	NA
SNJ54S37FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54S37FK.A	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54S37W	W	CFP	14	25	506.98	26.16	6220	NA
SNJ54S37W.A	W	CFP	14	25	506.98	26.16	6220	NA

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



D0014A



PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
- 5. Reference JEDEC registration MS-012, variation AB.



D0014A

EXAMPLE BOARD LAYOUT

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



D0014A

EXAMPLE STENCIL DESIGN

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14



FK 20

8.89 x 8.89, 1.27 mm pitch

GENERIC PACKAGE VIEW

LCCC - 2.03 mm max height

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





GENERIC PACKAGE VIEW

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



J0014A



PACKAGE OUTLINE

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



J0014A

EXAMPLE BOARD LAYOUT

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





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